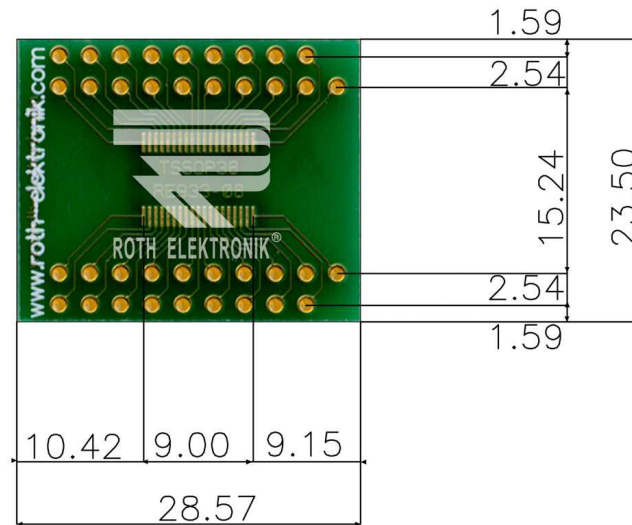




RE933-08

- Epoxy fibre-glass FR4 1.50 mm
 - Double-sided 35 µm Cu
 - Plated through holes (PTH)
 - Surface chem. Ni/Au with solder stop mask
 - Adaption circuit board for TSSOP 38
 - Pitch: 0.50 mm (173 mil)
 - Hole diameter 1.00 mm
 - Size 23.50 x 28.57 mm
- Module-No. Pitch mil Pin Size (mm)

RE933-08 0.500 mm 19.6 38 6.100 (240 mil)